SERVICES OFFERED

- Onsite Semiconductor Programming
- Commercial and Military IC Testing and Qualification
- Flash Memory Programming and Re-Programming
- Marking and Labeling
- Component Sourcing
- Tape and Reel Featuring Peel Force Testing
- Industrial Temperature Screening
- Stabilization Bake and Dry Packaging
- Kitting and Labeling for Field Upgrade or BOM
  Using Conductive Foam and Shrink Wrap for a Turnkey Solution
- Sourcing Obsolete and Allocated Components
- Counterfeit Screening

FEATURES AND BENEFITS

- Local Service and Support
- 24 Hour First Article Sample
- Prototype Through Production Capabilities of Mixed Program Types
- High Volume Production
- Full Support for Most Field Programmable Semiconductors
- Diverse Capabilities for Various Manufacturer Technologies
- Automated Programming Support for Most Package Types
- Supports - SOIC, PLCC, SSOP, TSOP, LCC, DIP, QFP, TQFP, PGA, BGA
- Serialization Encoding and Labeling
- Component Testing and Qualification
- Tape and Reel for Surface Mount Devices (SMD) and Most Components
- Large Carrier Tape Inventory
- Quality Maintenance Program
- Largest Dedicated Actel Support Center

ASSET AND RECOVERY SERVICES AND MANUFACTURERS SUPPORTED

- Value Added Services for Recycling Reprogrammable Logic
  and Memory Devices
- Component Management

- Actel
- Altera
- Analog Devices
- AMD
- Atmel
- Cypress
- Dallas
- Fairchild
- Freescale
- Fujitsu
- Hitachi
- Hyundai
- Intel
- Lattice
- Macronix
- Maxim
- Microchip
- Motorola
- National Semi
- NEC
- Numonyx
- OKI
- Panasonic
- Phillips
- Raytheon
- ST Micro
- Samsung
- Siemens
- Sony
- Spansion
- SST
- TI
- Toshiba
- Wafer Scale
- Western Digital
- Xicore
- Xilinx
- Xilinx